

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

1. (currently amended): A volume hologram transfer foil comprising a multilayer structure, which comprises a substrate, a ~~[[t]]~~ surface protective layer, a ~~thermoplastic~~ thermoplastic resin layer comprising a coating layer in which a heat-sealable, water-soluble adhesive agent is dissolved or dispersed ~~in water or a solvent~~ therein, a volume hologram layer and a heat seal layer laminated thereon in this order, wherein:

when said volume hologram transfer foil is applied on said heat seal layer to an application member, a peel force between said substrate and said surface protective layer is smaller than that between other adjacent layers in said multilayer structure.

2. (currently amended): The volume hologram transfer foil according to claim 1, wherein said thermoplastic resin layer has a softening point of 55°C to 200°C while said heat seal layer has a softening point of 50°C to 195°C, and the softening point of said thermoplastic resin layer is at least 5°C higher than the softening point of said heat seal layer. ~~[[.]]~~

3. (previously presented): The volume hologram transfer foil according to claim 1, wherein said thermoplastic resin layer and said heat seal layer are each dry laminated on said volume hologram layer.



4. (previously presented): The volume hologram transfer foil according to claim 1, which further comprises a releasable sheet laminated on a surface of said heat seal layer.

5. (canceled).

6. (canceled).

7. (currently amended): The volume hologram transfer foil according to claim 1, which further comprises a ~~release~~ releasable sheet laminated on the surface of said heat seal layer.